ESCC				DOCUMENT CHANGE REQUEST		
DCR number	1334	Changes re	quired for: Ge	neral	Originator: Leny Baczkowski	
Date: 2020/06/18 Date sent: 2020/04/01			2020/04/01		Organisation: CNES	
Status: IMPLEMENTED						
Title:	Requirements for Lead Materials and Finishes for Components for Space Application					
Number:	23500 Iss		Issue:	6		
Other documents affected:						
Page:						
7						
Paragraph:						
3.3 ; Description of Type 3 in the table						
Original wording:						
The tin-lead plating shall be in accordance with the best commercial practice and have a composition of 30 to 70% tin (remainder lead).						
Proposed wording:						
The tin-lead plating shall be in accordance with the best commercial practice and have a composition of 30 to 95% tin (remainder lead).						
Justification:						
Proposal to extend tin content in allow since the two qualified relays manufacters use tin-lead plating with 95% tin content.						
Attachments:						
N/A						
Modifications:						
The description of Type 3 shall not be increased to 95% tin. Concern is that some manufacturers will change their tin-lead composite to a higher tin percentage. ESCC requires special precautions for 85% to 95% tin. Therefore, DLR proposal is to add a new type 19 for the relay manufacturers' SnPb with a tin percentage between 85% and 95%. Furthermore, solder behavior of 95% Sn is slightly different to eutectic composition. DCR accepted						
Approval signature:						
Sade						
Date signed:						

2020-06-18